



DEC 23 2005

IFW

Docket No. 5000-5118

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant(s) : Tomohei SUGIYAMA et al.      Group Art Unit: 2891  
Serial No : 10/626,418      Examiner: D. Menz  
Filed : July 23, 2003  
For : METHOD OF MANUFACTURING A LOW EXPANSION MATERIAL  
AND SEMICONDUCTOR DEVICE USING THE LOW EXPANSION  
MATERIAL

**AMENDMENT AND RESPONSE TO OFFICE ACTION**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Responsive to the Official Action (non-final rejection) dated September 22, 2005,  
Applicants respectfully request reconsideration in view of the following amendments and  
remarks.

**Amendments to the Claims** are reflected in the listing of claims which begins on  
page 2 of this paper.

**Amendments to Figure 9** are attached.

**Remarks/Arguments** begin on page 5 of this paper.